Complementary ThermalTrakTM Transistors

The ThermalTrak family of devices has been designed to eliminate thermal equilibrium lag time and bias trimming in audio amplifier applications. They can also be used in other applications as transistor die protection devices.

Features

- Thermally Matched Bias Diode
- Instant Thermal Bias Tracking
- Absolute Thermal Integrity
- Medium Frequency Device with Extended Safe Operating Area
- These are Pb-Free Devices

Benefits

- Eliminates Thermal Equilibrium Lag Time and Bias Trimming
- Superior Sound Quality Through Improved Dynamic Temperature Response
- Significantly Improved Bias Stability
- Simplified Assembly
 - Reduced Labor Costs
 - Reduced Component Count
- High Reliability

Applications

- High-End Consumer Audio Products
 - Home Amplifiers
 - Home Receivers
- Professional Audio Amplifiers
 - Theater and Stadium Sound Systems
 - ◆ Public Address Systems (PAs)



ON Semiconductor®

http://onsemi.com

BIPOLAR POWER TRANSISTORS 16 A, 250 V, 200 W

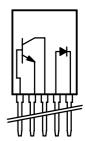


TO-264, 5 LEAD CASE 340AA STYLE 1

MARKING DIAGRAM

SCHEMATIC





xxxx = Specific Device Code
G = Pb-Free Device
A = Assembly Location

YY = Year WW = Work Week

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MAXIMUM RATINGS ($T_J = 25^{\circ}C$ unless otherwise noted)

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V _{CEO}	250	Vdc
Collector-Base Voltage	V _{CBO}	400	Vdc
Emitter–Base Voltage	V _{EBO}	5	Vdc
Collector–Emitter Voltage – 1.5 V	V _{CEX}	400	Vdc
Collector Current – Continuous – Peak (Note 1)	I _C	16 30	Adc
Base Current – Continuous	I _B	5.0	Adc
Total Power Dissipation @ T _C = 25°C Derate Above 25°C	P _D	200 1.43	W W/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	- 65 to +150	°C
DC Blocking Voltage	V _R	200	V
Average Rectified Forward Current	I _{F(AV)}	1.0	A

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	0.625	°C/W

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. Pulse Test: Pulse Width = 5 ms, Duty Cycle < 10%.

ATTRIBUTES

Char	acteristic	Value	
ESD Protection	Human Body Model Machine Model	>8000 V > 400 V	
Flammability Rating		UL 94 V-0 @ 0.125 in	

ORDERING INFORMATION

Device	Package	Shipping
NJL21193DG	TO-264 (Pb-Free)	25 Units / Rail
NJL21194DG	TO-264 (Pb-Free)	25 Units / Rail

ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS				
Collector–Emitter Sustaining Voltage (I _C = 100 mAdc, I _B = 0)	V _{CEO(sus)}	250	_	Vdc
Collector Cutoff Current (V _{CE} = 200 Vdc, I _B = 0)	I _{CEO}	-	100	μAdc
Emitter Cutoff Current (V _{CE} = 5 Vdc, I _C = 0)	I _{EBO}	_	100	μAdc
Collector Cutoff Current (V _{CE} = 250 Vdc, V _{BE(off)} = 1.5 Vdc)	I _{CEX}	-	100	μAdc
SECOND BREAKDOWN				
Second Breakdown Collector Current with Base Forward Biased (V _{CE} = 50 Vdc, t = 1 s (non–repetitive) (V _{CE} = 80 Vdc, t = 1 s (non–repetitive)	I _{S/b}	4.0 2.25	- -	Adc
ON CHARACTERISTICS				
DC Current Gain ($I_C = 8$ Adc, $V_{CE} = 5$ Vdc) ($I_C = 16$ Adc, $I_B = 5$ Adc)	h _{FE}	25 8	75 -	
Base–Emitter On Voltage (I _C = 8 Adc, V _{CE} = 5 Vdc)	V _{BE(on)}	-	2.2	Vdc
Collector–Emitter Saturation Voltage ($I_C = 8$ Adc, $I_B = 0.8$ Adc) ($I_C = 16$ Adc, $I_B = 3.2$ Adc)	V _{CE(sat)}	- -	1.4 4	Vdc
DYNAMIC CHARACTERISTICS				
Total Harmonic Distortion at the Output $V_{RMS} = 28.3 \text{ V}, f = 1 \text{ kHz}, P_{LOAD} = 100 \text{ W}_{RMS}$ h_{FE} unmatched (Matched pair $h_{FE} = 50 \ @ 5 \text{ A/5 V}$) h_{FE} matched	T _{HD}	-	-	%
Current Gain Bandwidth Product ($I_C = 1$ Adc, $V_{CE} = 10$ Vdc, $f_{test} = 1$ MHz)	f _T	4	_	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f _{test} = 1 MHz)	C _{ob}	-	500	pF
Maximum Instantaneous Forward Voltage (Note 2) $(i_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C})$ $(i_F = 1.0 \text{ A}, T_J = 150^{\circ}\text{C})$	VF	1.1 0.93		V
Maximum Instantaneous Reverse Current (Note 2) (Rated dc Voltage, $T_J = 25^{\circ}C$) (Rated dc Voltage, $T_J = 150^{\circ}C$)	i _R		0	μΑ
Maximum Reverse Recovery Time $(i_F = 1.0 \text{ A, di/dt} = 50 \text{ A/}\mu\text{s})$	t _{rr}	t _{rr} 100		

^{2.} Diode Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

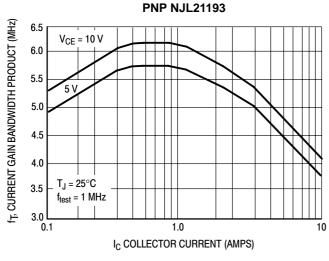


Figure 1. Typical Current Gain Bandwidth Product

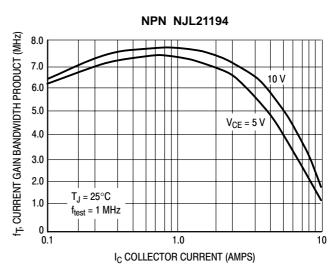


Figure 2. Typical Current Gain Bandwidth Product

TYPICAL CHARACTERISTICS

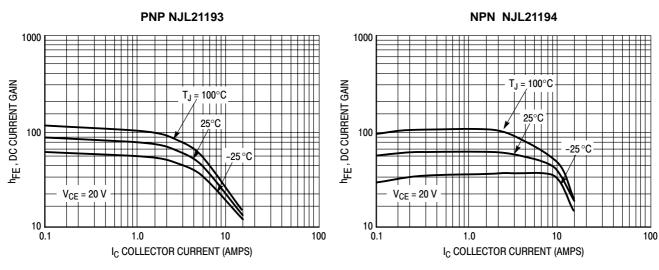


Figure 3. DC Current Gain, V_{CE} = 20 V

Figure 4. DC Current Gain, V_{CE} = 20 V

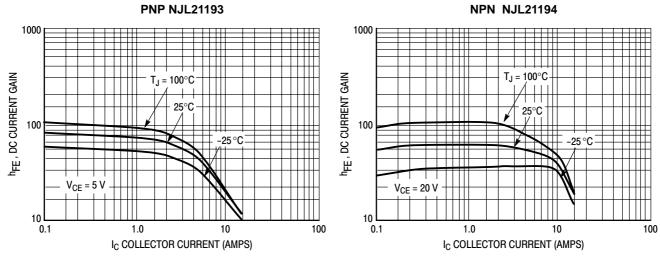
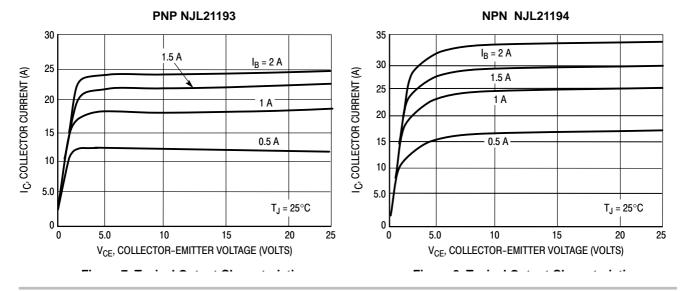


Figure 5. DC Current Gain, V_{CE} = 5 V

Figure 6. DC Current Gain, $V_{CE} = 5 \text{ V}$



TYPICAL CHARACTERISTICS

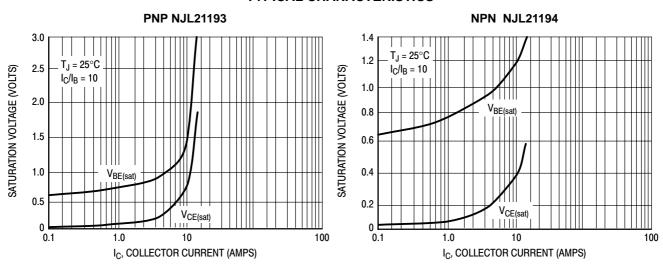


Figure 9. Typical Saturation Voltages

Figure 10. Typical Saturation Voltages

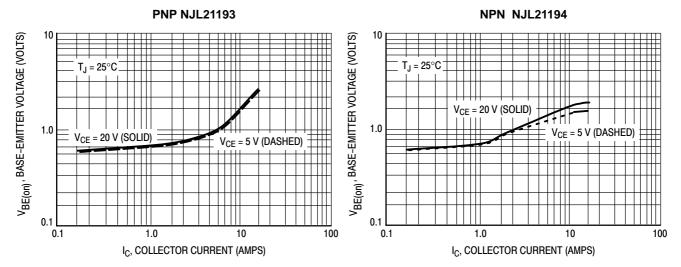


Figure 11. Typical Base-Emitter Voltage

Figure 12. Typical Base-Emitter Voltage

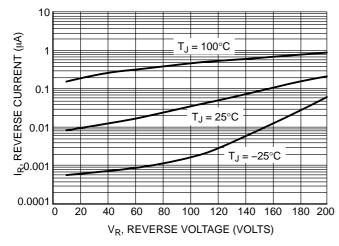


Figure 13. Typical Reverse Current

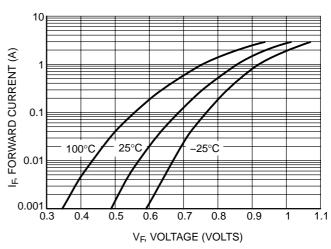


Figure 14. Typical Forward Voltage

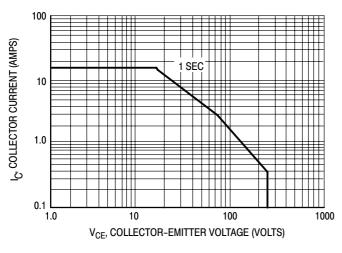


Figure 15. Active Region Safe Operating Area

There are two limitations on the power handling ability of a transistor; average junction temperature and secondary breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 15 is based on $T_{J(pk)} = 150^{\circ}\text{C}$; T_{C} is variable depending on conditions. At high case temperatures, thermal limitations will reduce the power than can be handled to values less than the limitations imposed by second breakdown.

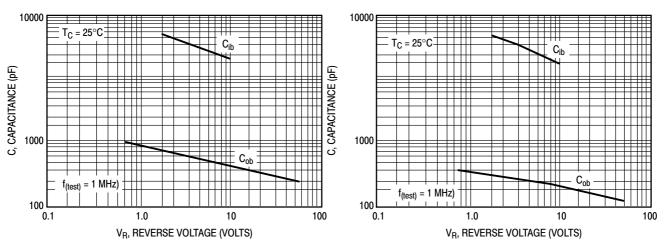


Figure 16. NJL21193 Typical Capacitance

Figure 17. NJL21194 Typical Capacitance

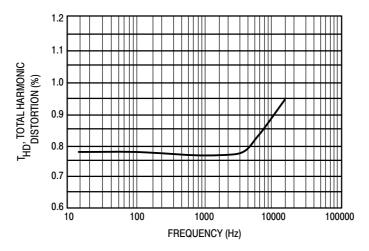


Figure 18. Typical Total Harmonic Distortion

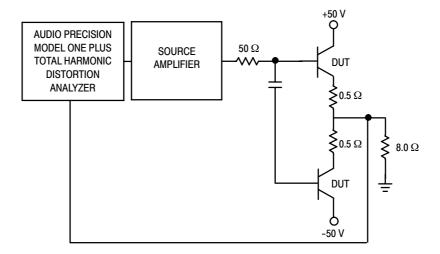
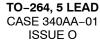
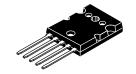


Figure 19. Total Harmonic Distortion Test Circuit

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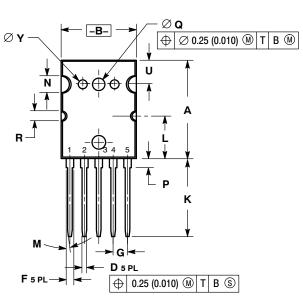


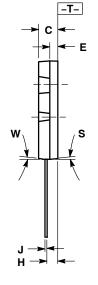


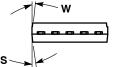
SCALE 1:2



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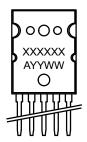


STYLE 1: PIN 1. BASE 2. EMITTER 3. COLLECTOR 4. ANODE 5. CATHODE

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	25.857	25.984	26.111	1.018	1.023	1.028	
В	19.761	19.888	20.015	0.778	0.783	0.788	
С	4.699	4.890	5.182	0.185	0.199	0.204	
D	1.	219 BS0	С	0.	0.0480 BSC		
Е	1.890	2.042	2.184	0.0748	0.0804	0.0860	
F	1.981 BSC			0.0780 BSC			
G	3	.81 BSC	;	0.150 BSC		С	
Н	2.667	2.718	2.769	0.1050	0.1070	0.1090	
J	0.584 BSC		0.0230 BSC				
K	20.422	20.549	20.676	0.804	0.809	0.814	
L	11.28 REF		0.444 REF				
M	0 °		7 °	0 °		7 °	
N	4.57 REF		0.180 REF				
Р	2.259	2.386	2.513	0.0889	0.0939	0.0989	
Q	3.480 BSC		0.1370 BSC				
R	2.54 REF		0.100 REF				
S	0 °		8 °	0 °		8 °	
U	6.17 REF		0.243 REF		EF		
W	0 °		6°	0 °		6 °	
Υ	2.388 BSC		0.0940 BSC				

GENERIC MARKING DIAGRAM*



XXXXXX = Specific Device Code = Assembly Location Α

ΥY = Year WW = Work Week = Pb-Free Package G or ■

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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